

MOSFET – Power, N-Channel, SUPERFET® III

800 V, 360 mΩ, 13 A

NTPF360N80S3Z

Description

800 V SUPERFET III MOSFET is **onsemi**'s high performance MOSFET family offering 800 V breakdown voltage.

New 800 V SUPERFET III MOSFET which is optimized for primary switch of flyback converter, enables lower switching losses and case temperature without sacrificing EMI performance thanks to its optimized design. In addition, internal Zener Diode significantly improves ESD capability.

This new family of 800 V SUPERFET III MOSFET enables to make more efficient, compact, cooler and more robust applications because of its remarkable performance in switching power applications such as Laptop adapter, Audio, Lighting, ATX power and industrial power supplies.

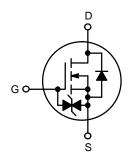
Features

- Typ. $R_{DS(on)} = 300 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 25.3 \text{ nC}$)
- Low Stored Energy in Output Capacitance (Eoss = 2.72 μJ @ 400 V)
- 100% Avalanche Tested
- ESD Improved Capability with Zener Diode
- RoHS Compliant

Applications

- Adapters / Chargers
- LED Lighting
- AUX Power
- Audio
- Industrial Power

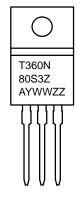
V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
800 V	360 m Ω	13 A	



POWER MOSFET



MARKING DIAGRAM



T360N80S3Z = Specific Device Code
A = Assembly Location
YWW = Date Code (Year & Week)
ZZ = Assembly Lot

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS ($T_J = 25^{\circ}C$, unless otherwise noted)

Symbol	Paran	Value	Unit		
V_{DSS}	Drain-to-Source Voltage	-to-Source Voltage		V	
V_{GS}	Gate-to-Source Voltage	DC	±20	V	
		AC (f > 1 Hz)	±30	1	
I _D	Drain Current	Continuous (T _C = 25°C)	13*	А	
		Continuous (T _C = 100°C)	8.2*		
I _{DM}	Drain Current	Pulsed (Note 1)	32.5*	А	
E _{AS}	Single Pulsed Avalanche Energy (Note	2)	40	mJ	
I _{AS}	Avalanche Current (Note 2)		2.0	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		0.31	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		10	1	
P_{D}	Power Dissipation	(T _C = 25°C)	31	W	
		Derate Above 25°C	0.168	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from Case for 10 seconds)		260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature 1. Repetitive rating: pulse–width limited by maximum junction temperature. 2. $I_{AS} = 2.0 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \leq 3.25 \text{ A}$, di/dt $\leq 200 \text{ A/}\mu\text{s}$, $V_{DD} \leq 400 \text{ V}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL RESISTANCE RATINGS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Junction-to-Case - Steady State	4.04	°C/W
$R_{\theta JA}$	R _{θ,JA} Junction–to–Ambient – Steady State		

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTPF360N80S3Z	T450N80S3Z	TO-220F	Tube	N/A	N/A	1000 Units

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	FERISTICS					
BV _{DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA, } T_J = 25^{\circ}\text{C}$	800			V
		V _{GS} = 0 V, I _D = 1 mA, T _J = 150°C	900			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C		1.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 800 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 640 V, T _C = 125°C		0.8		
I _{GSS}	Gate-to-Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			1	μΑ
ON CHARACTI	ERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 0.3 \text{ mA}$	2.2		3.8	V
R _{DS(on)}	Static Drain-to-Source On Resistance	V _{GS} = 10 V, I _D = 6.5 A		300	360	mΩ
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 6.5 A		13.8		S
DYNAMIC CHA	RACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 250 \text{ kHz}$		1143		pF
C _{oss}	Output Capacitance]		18.1		pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		236.4		pF
C _{oss(er.)}	Energy Related Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		34		pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, I_{D} = 6.5 \text{ A}, V_{GS} = 10 \text{ V}$		25.3		nC
Q _{gs}	Gate-to-Source Gate Charge	(Note 4)		5.3		nC
Q_{gd}	Gate-to-Drain "Miller" Charge]		8.3		nC
ESR	Equivalent Series Resistance	f = 1 MHz		4		Ω
SWITCHING CI	HARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_D = 6.5 \text{ A}, V_{GS} = 10 \text{ V},$		21.2		ns
t _r	Turn-On Rise Time	$R_g = 25 \Omega$ (Note 4)		18.5		ns
t _{d(off)}	Turn-Off Delay Time			110		ns
t _f	Turn-Off Fall Time]		17.7		ns
SOURCE-DRA	IN DIODE CHARACTERISTICS			•		
Is	Maximum Continuous Source-to-Drain Diode Forward Current				13	Α
I _{SM}	Maximum Pulsed Source-to-Drain Diode Forward Current				32.5	Α
V _{SD}	Source-to-Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 6.5 \text{ A}$			1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 3.25 \text{ A},$		370		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs		3.0		μС

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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^{4.} Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

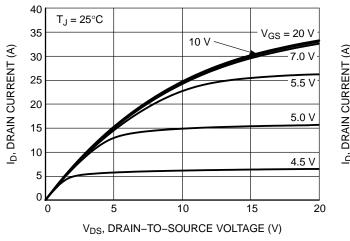


Figure 1. On-Region Characteristics

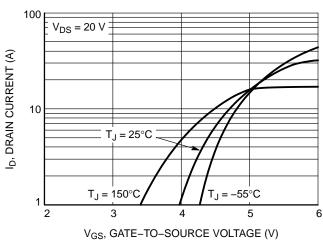


Figure 2. Transfer Characteristics

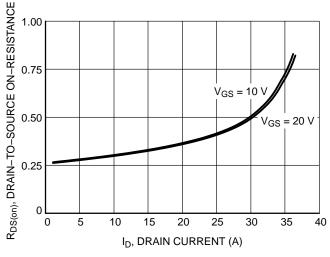


Figure 3. On Resistance vs. Drain Current

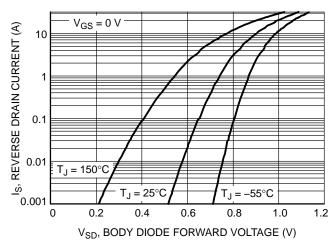


Figure 4. Diode Forward Voltage vs. Current

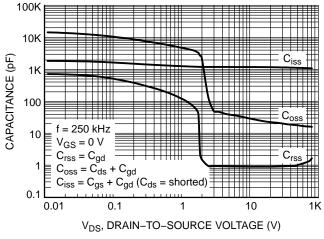


Figure 5. Capacitance Characteristics

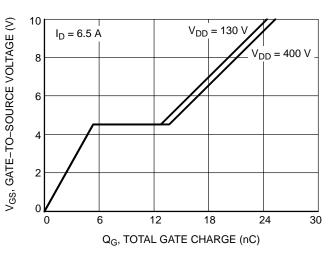


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS

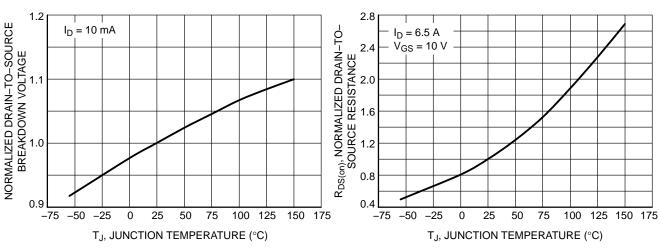
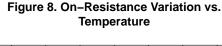


Figure 7. Normalized BV_{DSS} vs. Temperature



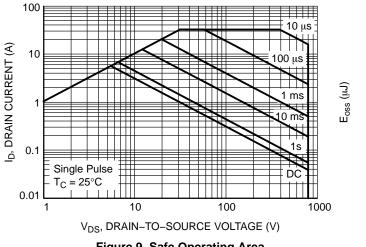


Figure 9. Safe Operating Area

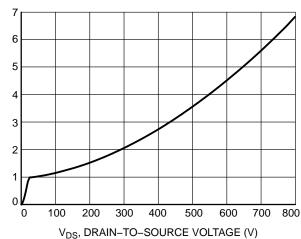


Figure 10. Eoss vs. Drain-to-Source Voltage

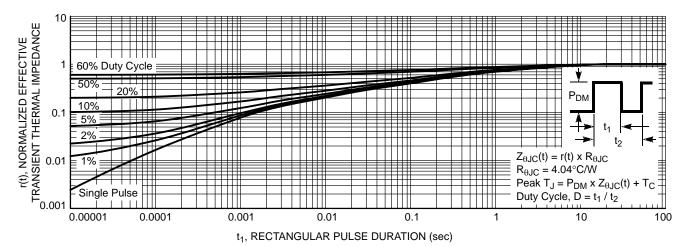


Figure 11. Transient Thermal Impedance

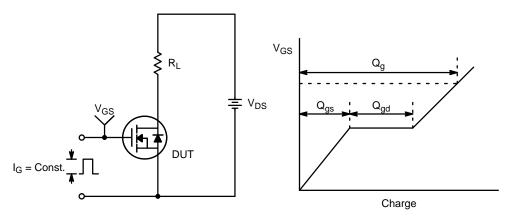


Figure 12. Gate Charge Test Circuit & Waveform

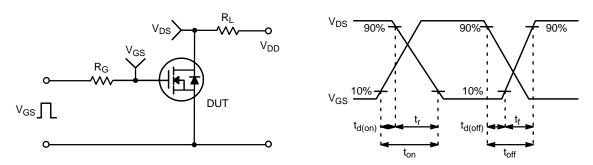


Figure 13. Resistive Switching Test Circuit & Waveforms

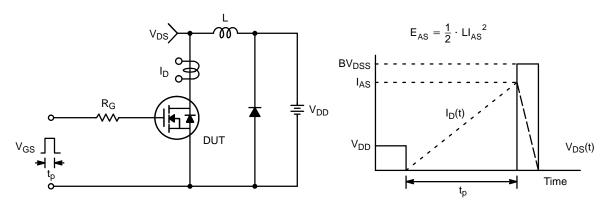


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

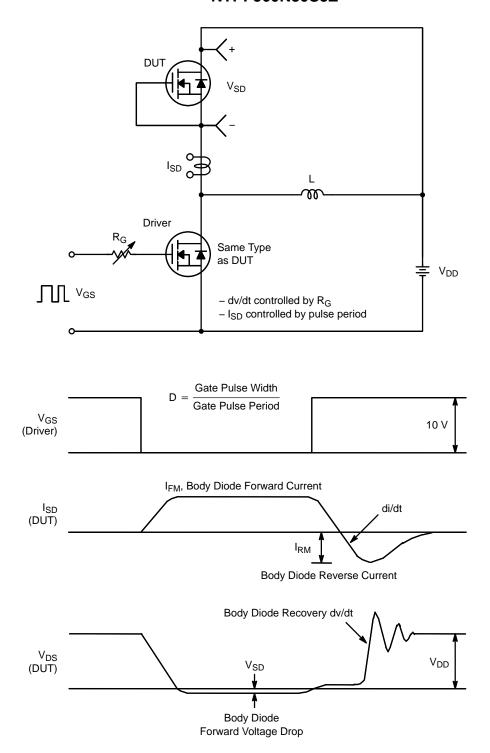


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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MECHANICAL CASE OUTLINE





SCALE 1:1

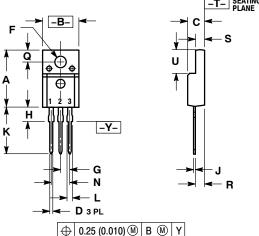
TO-220 FULLPAK CASE 221D-03 ISSUE K

DATE 27 FEB 2009



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH
- 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03.

	INCHES		MILLIN	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.617	0.635	15.67	16.12	
В	0.392	0.419	9.96	10.63	
C	0.177	0.193	4.50	4.90	
D	0.024	0.039	0.60	1.00	
F	0.116	0.129	2.95	3.28	
G	0.100	BSC	2.54 BSC		
Н	0.118	0.135	3.00	3.43	
J	0.018	0.025	0.45	0.63	
K	0.503	0.541	12.78	13.73	
L	0.048	0.058	1.23	1.47	
N	0.200	0.200 BSC 5.08		BSC	
Q	0.122	0.138	3.10	3.50	
R	0.099	0.117	2.51	2.96	
S	0.092	0.113	2.34	2.87	
U	0.239	0.271	6.06	6.88	



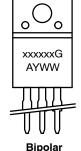
MARKING DIAGRAMS

STYLE 1: PIN 1. GATE STYLE 2: PIN 1. BASE 2. COLLECTOR 3. EMITTER 2. DRAIN 2. 3. SOURCE

STYLE 3: PIN 1. ANODE 2. CATHODE 3. ANODE

STYLE 4: PIN 1. CATHODE ANODE 3. CATHODE

STYLE 6: PIN 1. MT 1 2. MT 2 3. GATE STYLE 5: PIN 1. CATHODE 2. ANODE 3. GATE



xxxxxx = Specific Device Code

Rectifier = Assembly Location

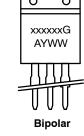
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AYWW

xxxxxxG

AKA

= Pb-Free Package Υ = Year = Work Week = Assembly Location WW = Year XXXXXX = Device Code = Pb-Free Package = Work Week G AKA = Polarity Designator



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